

High-Voltage Types (20-Volt Rating)

XL4514 Output "High" on Select

XD4514 Output "Low" on Select

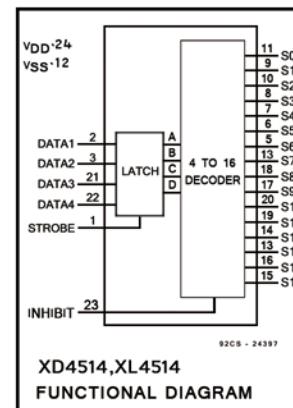
■ XL4514 and -XD4514 consist of a 4-bit strobed latch and a 4-to-16-line decoder. The latches hold the last input datapresented prior to the strobe transition from 1 to 0. Inhibit control allows all outputs to be placed at 0(XL4514) or 1(XD4514) regardless of the state of the data or strobe inputs. The decode truth table indicates all combinations of data inputs and appropriate selected outputs. These devices are similar to industry types XL4514 and XD4514.

Features:

- Strobed input latch
- Inhibit control
- 100% tested for quiescent current at 20V
- Maximum input current of 1 μ A at 18V over full package-temperature range; 100 nA at 18V and 25°C
- Noise margin(over full package temperature range):
 - 1V at $V_{DD} = 5V$
 - 1V at $V_{DD} = 10V$
 - 2.5V at $V_{DD} = 15V$
- 5-V,10-V, and 15-V parametric ratings
- Standardized,symmetrical output characteristics
- Meets all requirements of JEDEC tentative Standard No. 13B;"Standard Specifications for Description of 'B'Series CMOS Devives"

Applications:

- Digital multiplexing
- Address decoding
- Hexadecimal/BCD decoding
- Program-counter decoding
- Control decoder



XL4514,XL4514
FUNCTIONAL DIAGRAM

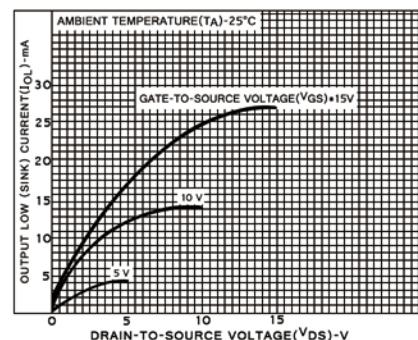


Fig.1-Typical output low (sink) current characteristics.

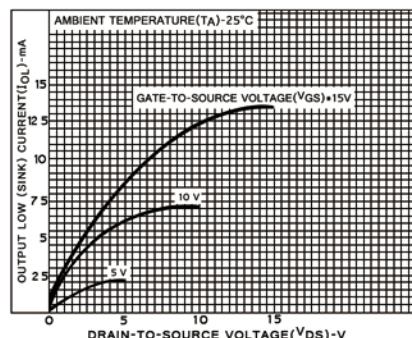


Fig. 2-Minimum output low (sink) current characteristics

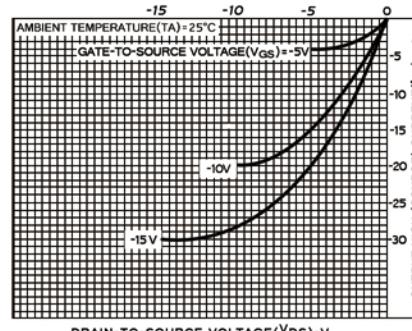


Fig.3-Typical output high (source) current characteristics.

MAXIMUM RATINGS,Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE,(V_{DD})

Voltages referenced to V_{SS} Terminal -0.5V to +20V

INPUT VOLTAGE RANGE,ALL INPUTS -0.5V to V_{DD} +0.5V

DC INPUT CURRENT,ANY ONE INPUT $\pm 10mA$

POWER DISSIPATION PER PACKAGE(P_D):

For $T_A = -55^\circ C$ to $+100^\circ C$ 500mW

For $T_A = +100^\circ C$ to $+125^\circ C$ Derate Linearity at $12mW/^\circ C$ to 200mW

DEVICE DISSIPATION PER OUTOUT TRANSISTOR

For $T_A =$ FULL PACKAGE-TEMPERATURE RANGE(All Package Types) 100mW

OPERATING-TEMP-TEMPERATURE RANGE(T_A) -55°C to +125°C

STORAGE TEMPERATURE RANGE(T_{stg}) -65°C to +150°C

LEAD TEMPERATURE(DURING SOLDERING):

At distance $1/16 \pm 1.32$ inch($1.59 \pm 0.79mm$)from casefor 10s max +265°C

RECOMMENDED OPERATING CONDITIONS at $T_A = 25^\circ C$,Except as Noted.

For maximum reliability,nominal operating conditions should be selected to that operation is always within the fllowing ranges:

CHARACTERISTIC	VDD (V)	LIMITS		UNITS
		Min.	Max.	
Supply-Voltage Range(For T_A =Full Pack age-Temperature Range)		3	18	V
Data Setup Time, t_S	5 10 15	150 70 40	-	ns
Strobe Pulse Width, t_W	5 10 15	250 100 25	-	ns

XL4514 SOP24/XD4514 DIP-24 XD74HC4514Z DIP窄24/XD14514 DIP-24

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)						UNITS	
	VO (V)	VN (V)	VDD (V)	+25			Min	Typ	Max		
				-55	-40	+85					
Quiescent Device Current, IDD Max	-	0,5	5	5	5	150	150	-	0.04	5	
	-	0,10	10	10	10	300	300	-	0.04	10	
	-	0,15	15	20	20	600	600	-	0.04	20	
	-	0,20	20	100	100	2000	3000	-	0.08	100	
Output Low (Sink) Current IOL Min	0,4	0,5	5	0,64	0,61	0,42	0,36	0,51	1	-	
	0,5	0,10	10	1,6	1,5	1,1	0,9	1,3	2,6	-	
	1,5	0,15	15	4,6	4	2,8	2,4	3,4	6,8	-	
Output High (Source) Current IOL Min	4,6	0,5	5	-0,64	-0,61	-0,42	-0,36	-0,51	-1	-	
	2,5	0,5	5	-2	-1,8	-1,3	-1,15	-1,6	-3,2	-	
	9,5	0,10	10	-1,6	-1,5	-1,1	-0,9	-1,3	-2,6	-	
	13,5	0,15	15	-4,2	-4	-2,8	-2,4	-3,4	-6,8	-	
Output Voltage: Low-level, VOI Max	-	0,5	5	0,05			-	0	0,05	V	
	-	0,10	10	0,05			-	0	0,05		
	-	0,15	15	0,05			-	0	0,05		
Output Voltage: High-Level, VOH Min	-	0,5	5	4,95			4,95	5	-	V	
	-	0,10	10	9,95			9,95	5	-		
	-	0,15	15	14,95			14,95	15	-		
Input Low Voltage, VIL Max	0,5,4,5	-	5	1,5			-	-	1,5	V	
	1,5	-	10	3			-	-	3		
	1,5,13,5	-	15	4			-	-	4		
Input High Voltage, VIH Min	0,5,4,5	-	5	3,5			3,5	-	-	V	
	1,9	-	10	7			7	-	-		
	1,5,13,5	-	15	11			11	-	-		
Input Current IIN Max	-	0,18	18	±0,1	±0,1	±1	±1	-	+10 ⁻⁵	±0,1	μA

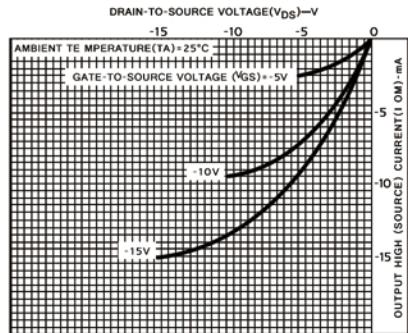


Fig.4-Minimum output high (source) current characteristics.

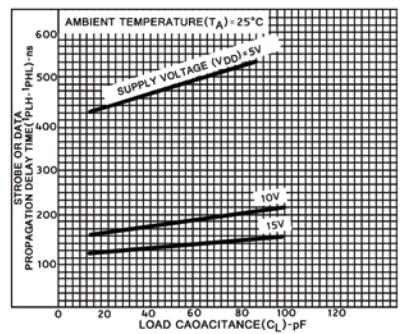


Fig.5-Typical strobe or data propagation delay time vs.load capacitance.

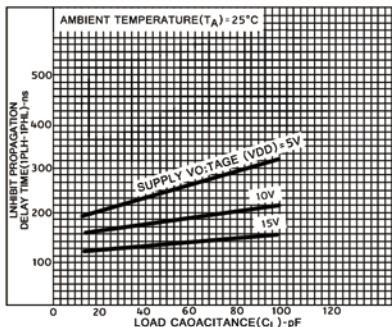


Fig.6-Typical inhibit propagation delay time vs.load capacitance.

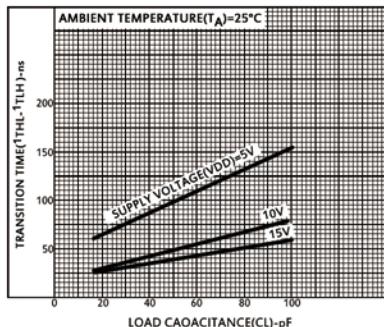


Fig.7-Typical low-to-high transition time vs. load capacitance.

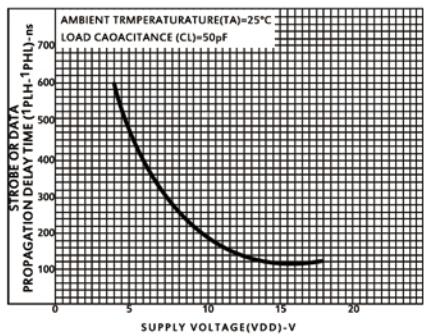


Fig.8-Typical strobe or data propagation delay time vs. supply voltage.

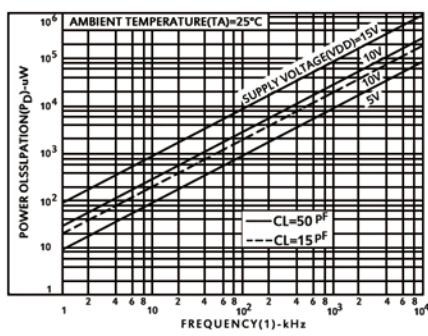


Fig.9-Typical power dissipation vs.frequency.

XL4514 SOP24/XD4514 DIP-24
XD74HC4514Z DIP窄24/XD14514 DIP-24

DYNAMIC ELECTRICAL CHARACTERISTICS at TA = 25°C; Input t_r, t_f = 20 ns,
 $C_L = 50 \text{ pF}, R_L = 200 \text{ k}\Omega$

CHARACTERISTIC	TEST CONDITIONS	LIMITS			UNITS
		V _{DD} V	Typ.	Max.	
Propagation Delay Time: t_{pHL}, t_{PLH} Strobe or Data		5 10 15	485 185 135	970 370 270	ns
Inhibit		5 10 15	250 110 85	500 220 170	
Transition Time, t_{TLH}, t_{THL}		5 10 15	100 50 40	200 100 80	
Minimum Strobe Pulse Width, t_W		5 10 15	125 50 40	250 100 75	ns
Minimum Data Setup Time, t_S		5 10 15	75 35 20	150 70 40	
Input Capacitance, C_{IN}	Any Input	-	5	7.5	pF

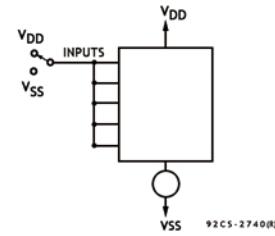


Fig.10—Quiescent device current test circuit.

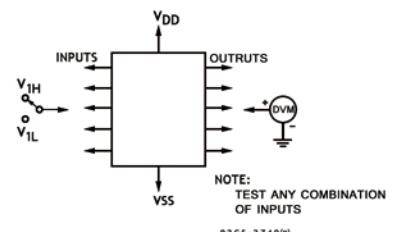


Fig.11—Input voltage test circuit

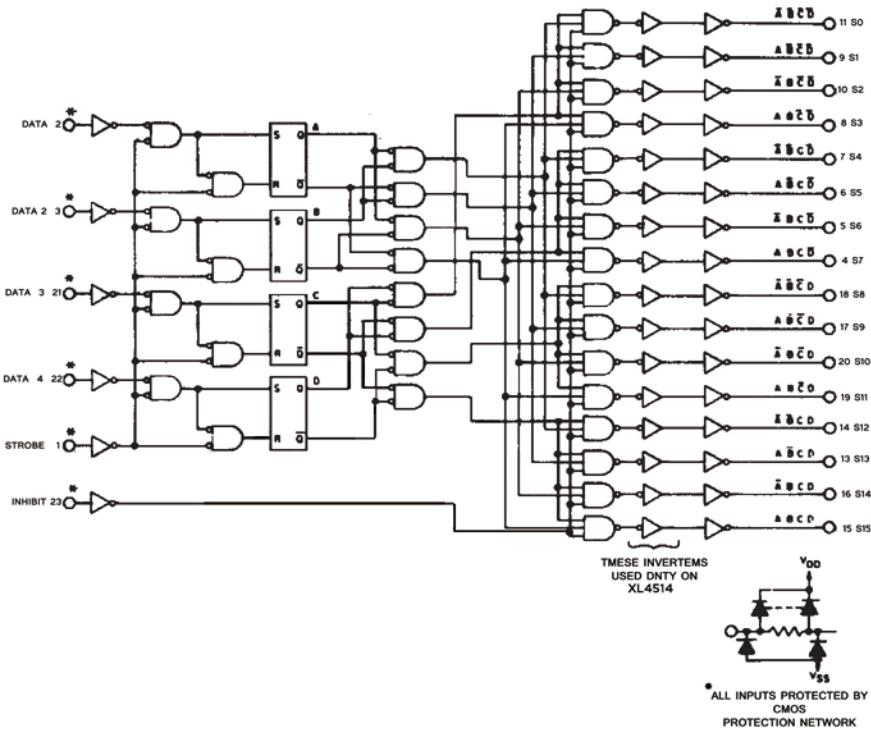


Fig.13—Logic diagram for XL4514 and XD4514

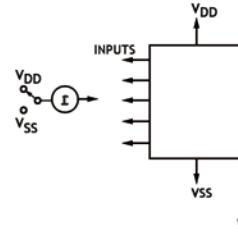


Fig. 12- Input current test circuit

**XL4514 SOP24/XD4514 DIP-24
XD74HC4514Z DIP窄24/XD14514 DIP-24**

DECODER TRUTH TABLE(Strobr=1)

INHIBIT	DECODER INPUTS				SELECTED OUTPUT XL4514 = Logic 1(High) XD4514 = Logic 0(Low)
	B	C	B	A	
0	0	0	0	0	S0
	0	0	0	1	S1
	0	0	0	0	S2
	0	0	0	1	S3
0	0	1	0	0	S4
	0	1	0	1	S5
	0	1	1	0	S6
	0	1	1	1	S7
0	1	0	0	0	S8
	1	0	0	1	S9
	1	0	1	0	S10
	1	0	1	1	S11
0	1	1	0	0	S12
	1	1	0	1	S13
	1	1	1	0	S14
	1	1	1	1	S15
1	X	X	X	X	All Outputs= 0, XL4514 All Outputs= 1, XD4514

X = Don't Care Logic 1 = high Logic 0 = Low

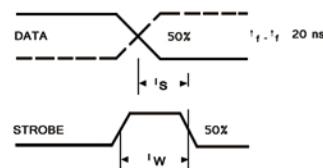
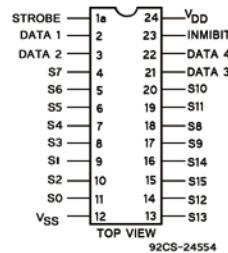
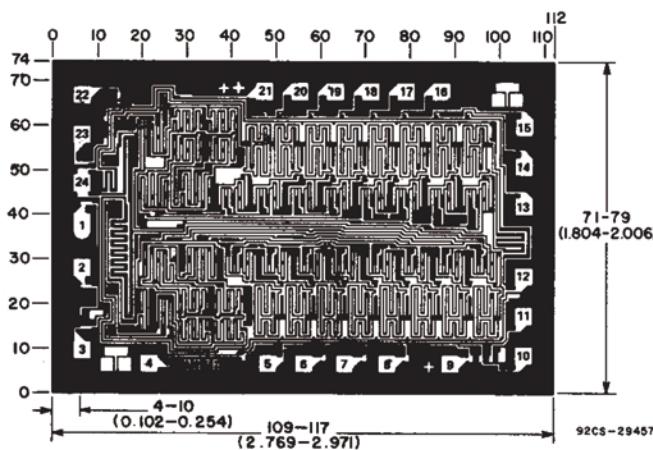


Fig.14-Waveforms for setup time and strobe pulse width



**XL4514
XD4514**

TERMINAL ASSIGNMENT



**Dimensions and Pad Layout for XL4514 Chip
(Dimensions and pad layout for the XD4514 are identical)**

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated.

Grid graduations are in mils (10^{-3} inch)

以上信息仅供参考. 如需帮助联系客服人员。谢谢 XINLUDA